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Standard Product Reference Sheet

VTEW1151ASE-57Y-TR



Features

Package	0.5 watt type, White color emitting LED (Color temperature:5,700K) Outer dimension 2.5 x 2.5 x 0.9mm (L x W x H)
Product features	<ul style="list-style-type: none"> •General color rendering index : Ra85 •Wide viewing angle 2θ1/2 : 145° •Sulfuretted countermeasure LED •Lead-free soldering compatible •RoHS compliant

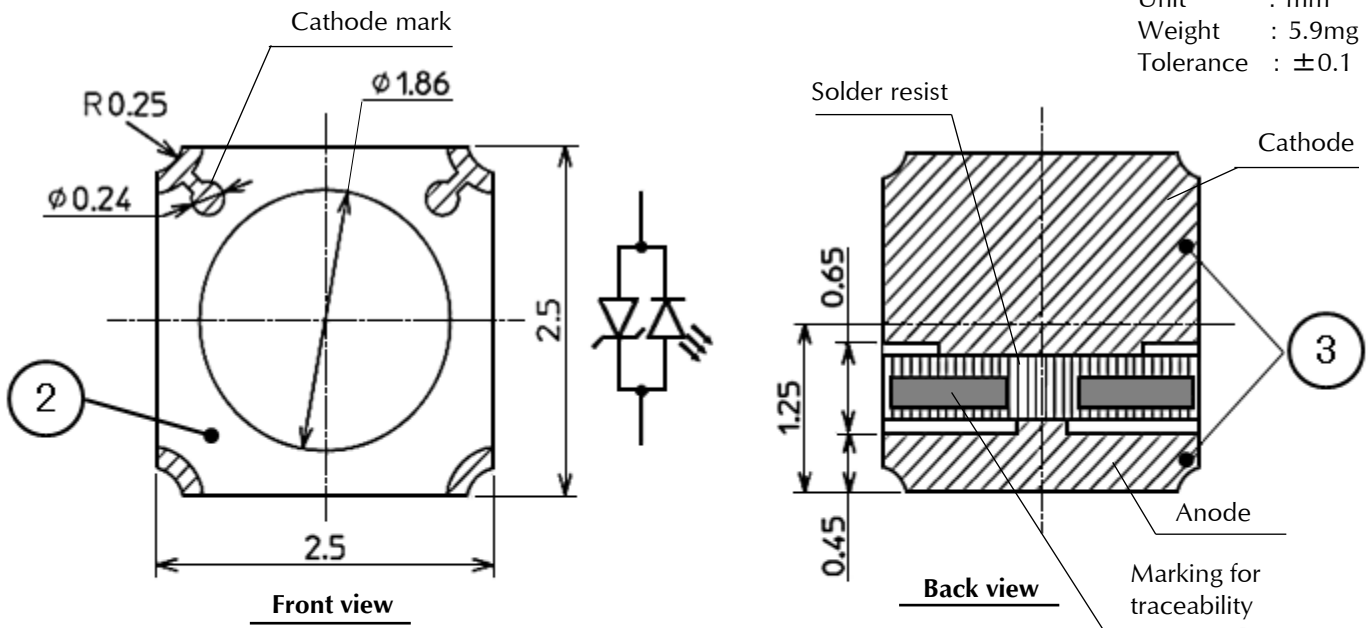
Recommended Applications

- Interior light for Automotive, Office lighting, Store lighting, other general lighting

Outline Dimensions

VTEW1151ASE-57Y-TR

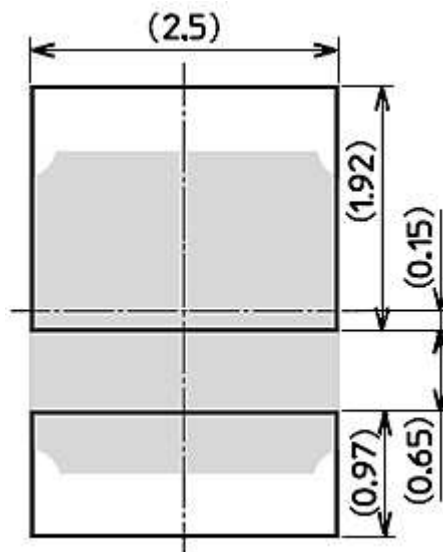
Unit : mm
 Weight : 5.9mg
 Tolerance : ±0.1



No.	Part Name	Material	QTY.
-	LED Die	InGaN	1
	Protection Diode	Si	1
①	Encapsulant	Silicone Resin	1
②	Substrate	Glass fabrics	1
③	Electrode	Au Plating	2

Recommended Soldering Pattern

Unit : mm



【 Product Overview 】

DIE MATERIAL	InGaN
EMITTING COLOR	White
RESIN COLOR 【EMITTING AREA】	Diffused Pale Yellow

【 Absolute Maximum Ratings 】

ITEM	SYMBOL	MAXIMUM RATINGS	UNITS	
Power Dissipation	P_d	655	mW	
Forward Current	I_F	170	mA	
I_F Derate Linearly from "Ts=90°C"	ΔI_F	2	mA/°C	
Allowable Reverse Voltage	V_R	0.6	V	
Operating Temperature	T_{opr}	-40 ~ +105	°C	Notes 1
Storage Temperature	T_{stg}	-40 ~ +125	°C	Notes 1
Electrostatic Discharge Threshold "HBM"	ESD	2,000	V	Notes 2
Junction Temperature	T_j	135	°C	
Solder Point Temperature	T_s	110	°C	Notes 3
Soldering Temperature "Reflow Soldering"	T_{sld}	260	°C	Notes 4

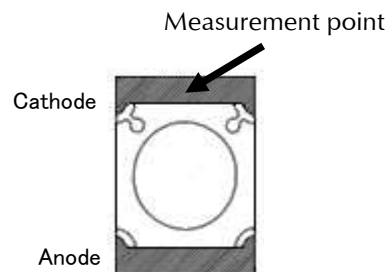
Notes 1 The range of operating and storage temperature is not taping condition.

Notes 2 ESD testing method : EIAJ4701/300(304) HBM 1.5K Ω , 100pF

Notes 3 Temperature measurement is made on cathode side of soldering pad.
(Please refer to right side figure.)

Noted 4 Please refer to Page 9, soldering conditions.

Baking is not needed before use.



【 Thermal Characteristics 】

ITEM	SYMBOL	TYP.	UNITS	
Thermal resistance 【Junction - solder point】	$R_{th(j-s)}$	40	°C/W	Notes 3

【 Electro-Optical Characteristics 】

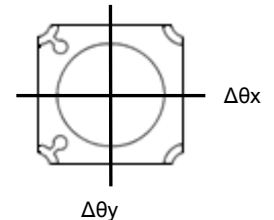
(Ts=25°C)						
ITEM	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Forward Voltage	V_F	$I_F = 150\text{mA}$	2.75	3.30	3.75	V
Reverse Voltage	V_R	$I_R = 10\text{mA}$	0.6	-	-	V
Luminous Flux	Φ_V	$I_F = 150\text{mA}$	27	37	47	lm
Efficiency	-	$I_F = 150\text{mA}$	-	75	-	lm/W
Chromaticity Coordinates	x	$I_F = 150\text{mA}$	-	0.329	-	/
	y	$I_F = 150\text{mA}$	-	0.342	-	
Half Intensity Angle	$\Delta \theta_x$	$I_F = 150\text{mA}$	-	145	-	deg.
	$\Delta \theta_y$		-	145	-	
General Color Rendering Index	Ra	$I_F = 150\text{mA}$	-	85	-	/
Color Temperature	-	$I_F = 150\text{mA}$	-	5,700	-	K

Notes 5 Please do not apply reverse voltage for prevent the product destruction, because ZD(protection diode) doesn't guarantee the opposite direction continuous current condition.

Notes 6 Please refer to the attached sheets, each sorting chart.

Notes 7 Chromaticity coordinates : x and y according to CIE1931.

Notes 8 Viewing Angle at 50% I_V , $\Delta \theta_x$, θ_y , as shown in the right side figure.



【 Sorting Chart for Luminous Flux ϕ_v 】

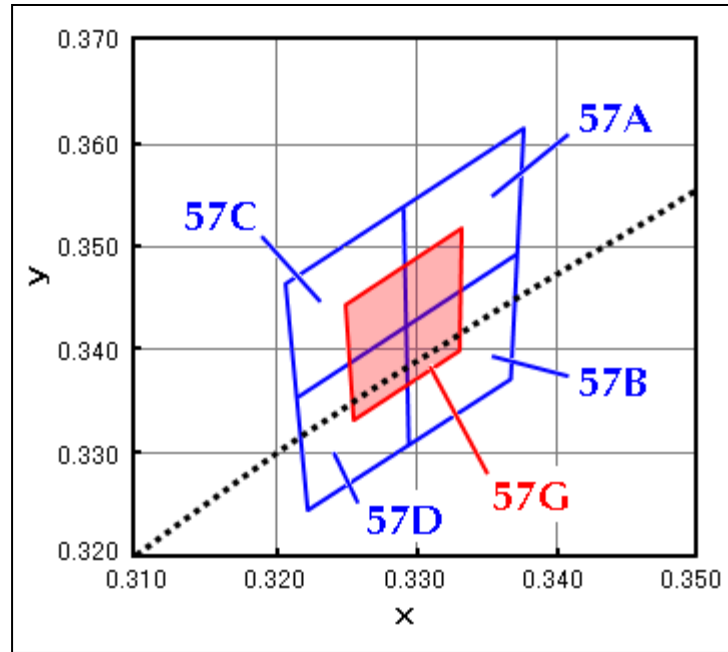
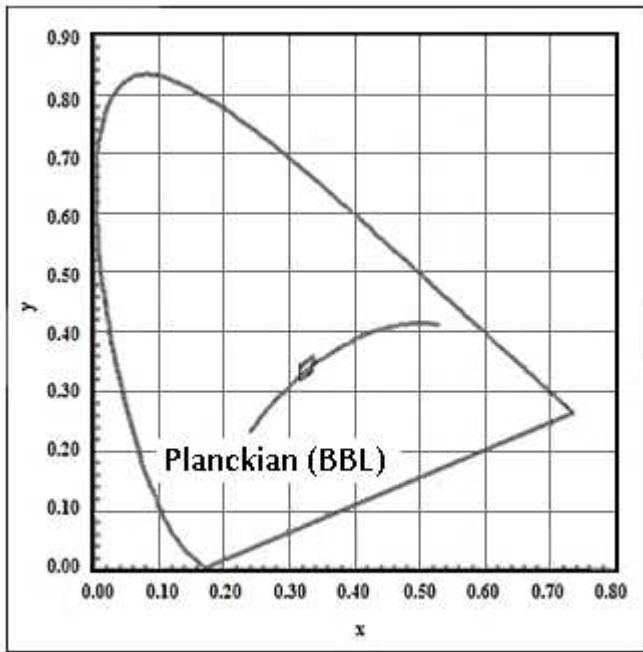
LEDs shall be sorted out into the following chart and each rank parts shall be pscked separately when shipping.

Rank	Luminous Flux Φ_V (lm)		Condition
	MIN.	MAX.	
B6	27	33	$I_F = 150\text{mA}$
B7	33	39	
B8	39	47	

Notes Tolerance each rank : $\pm 10\%$

【 Sorting chart For Chromaticity coordinates 】

Chromaticity coordinates shall be sorted out into the following chart and each rank parts shall be packed separately when shipping.



General color temperature
5,700K (5,310K~6,020K)

(Ta=25°C If=150mA)

Rank	x	y
57A	0.3293	0.3423
	0.3292	0.3539
	0.3376	0.3616
	0.3371	0.3493

Rank	x	y
57B	0.3294	0.3306
	0.3293	0.3423
	0.3371	0.3493
	0.3366	0.3369

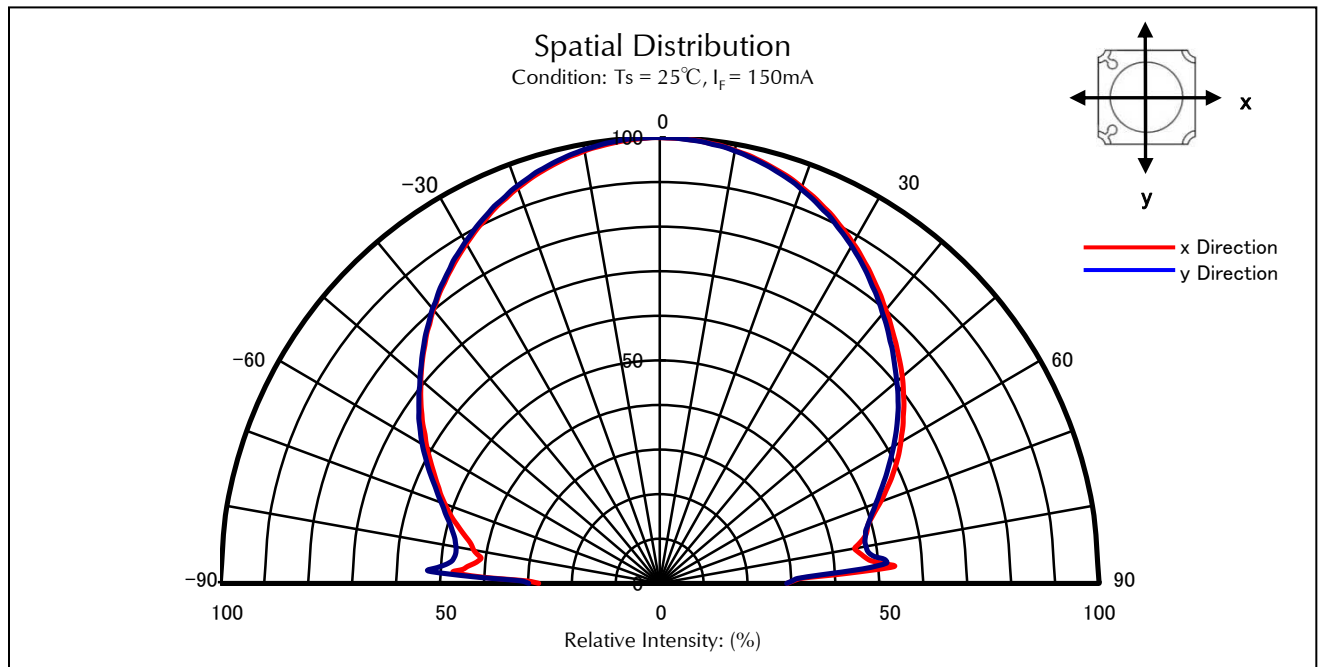
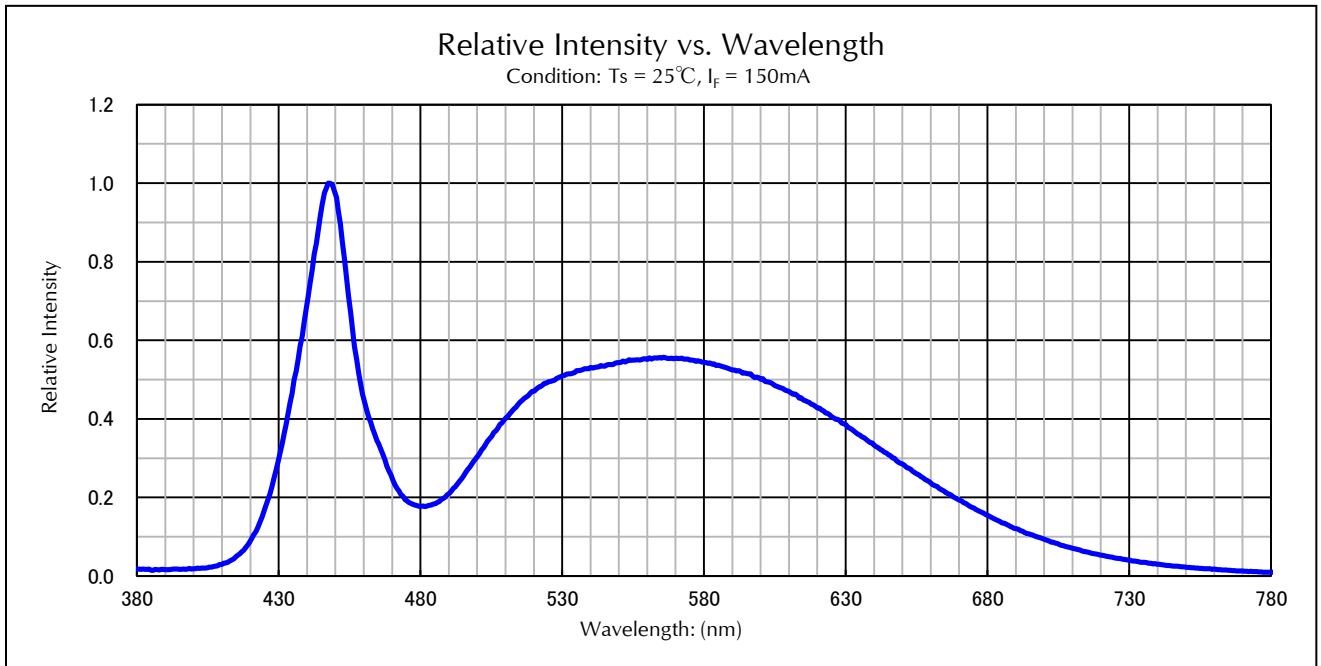
Rank	x	y
57C	0.3215	0.3353
	0.3207	0.3462
	0.3292	0.3539
	0.3293	0.3423

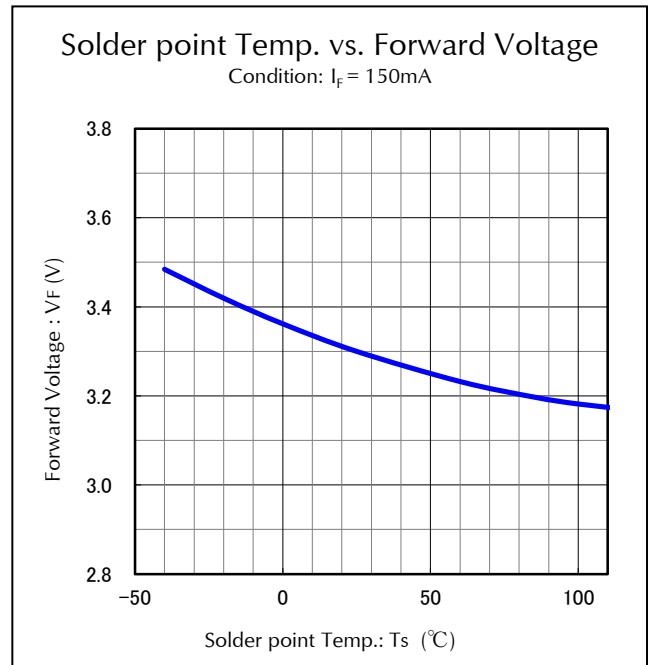
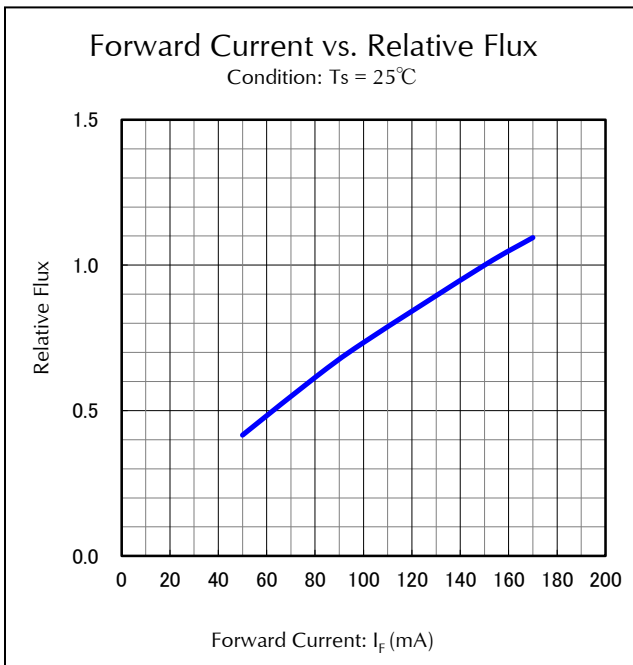
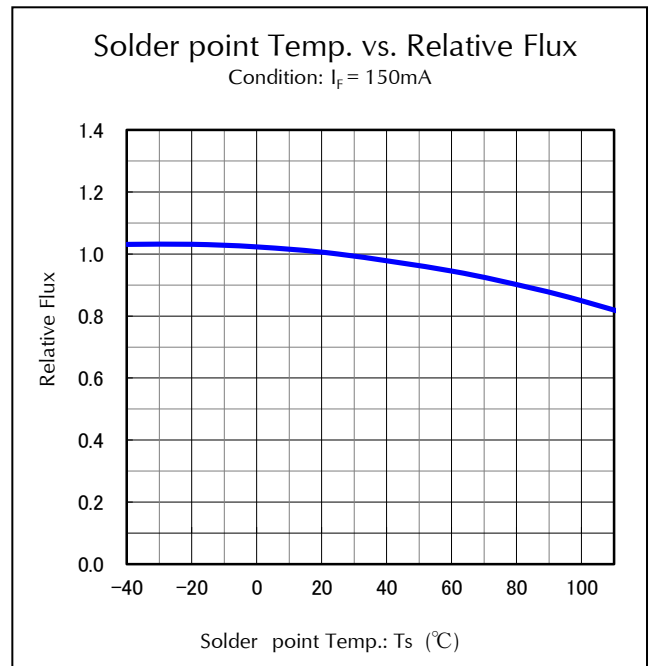
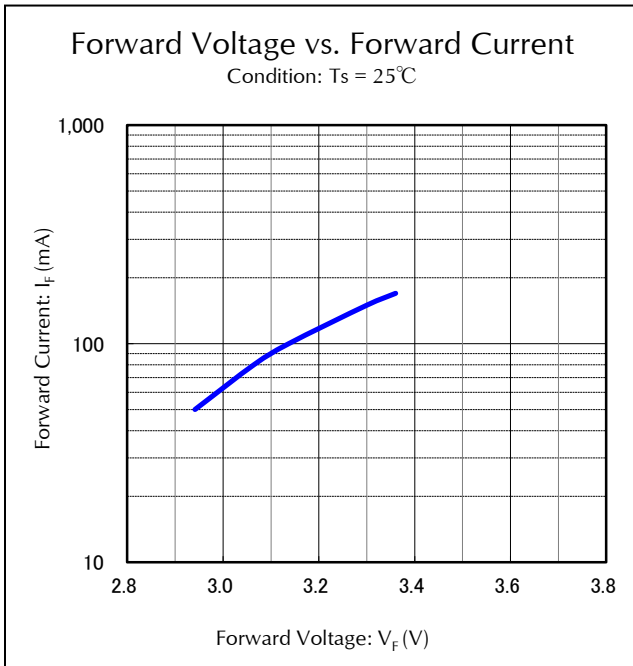
Rank	x	y
57D	0.3222	0.3243
	0.3215	0.3353
	0.3293	0.3423
	0.3294	0.3306

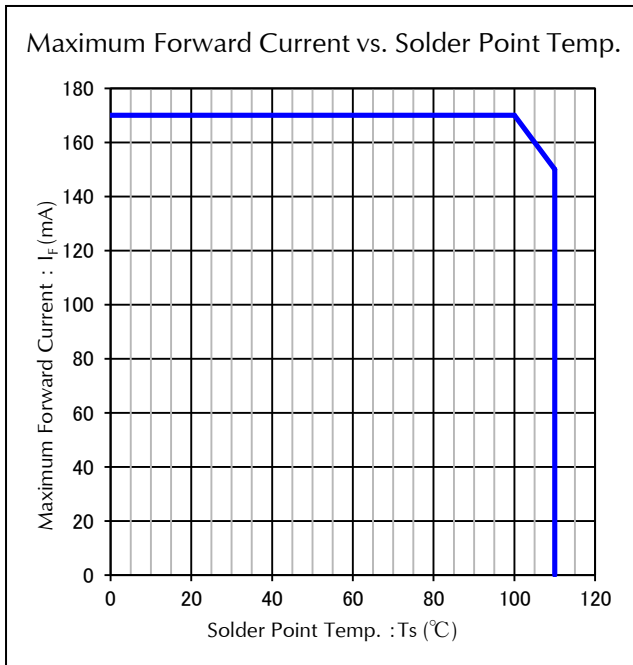
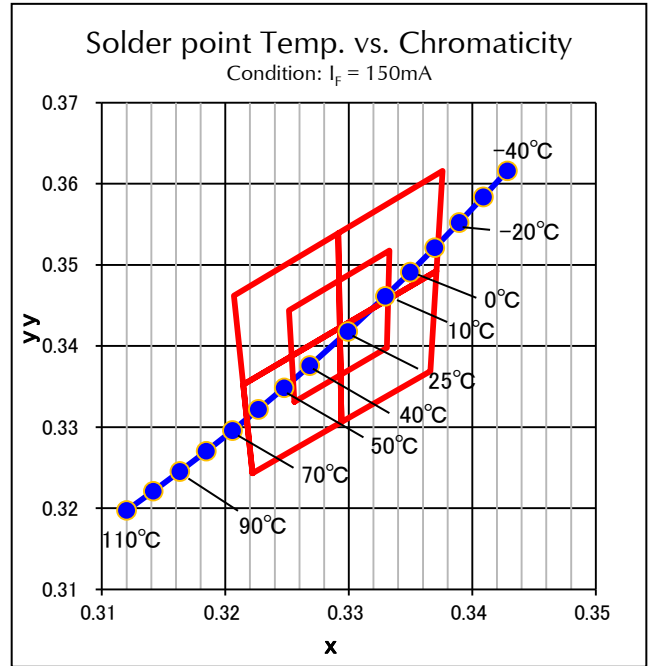
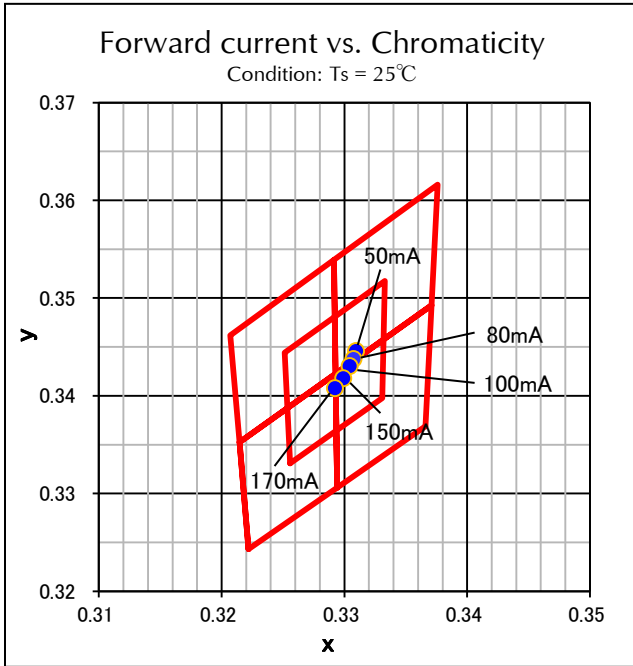
Rank	x	y
57G	0.3256	0.3331
	0.3251	0.3444
	0.3333	0.3518
	0.3331	0.3398

Notes

- Chromaticity coordinates Tolerance each rank : ± 0.01
- Chromaticity rank will ship by 5 ranks (A, B, C, D, and G).
- **Rank G will overlap with Rank A,B,C,D.**



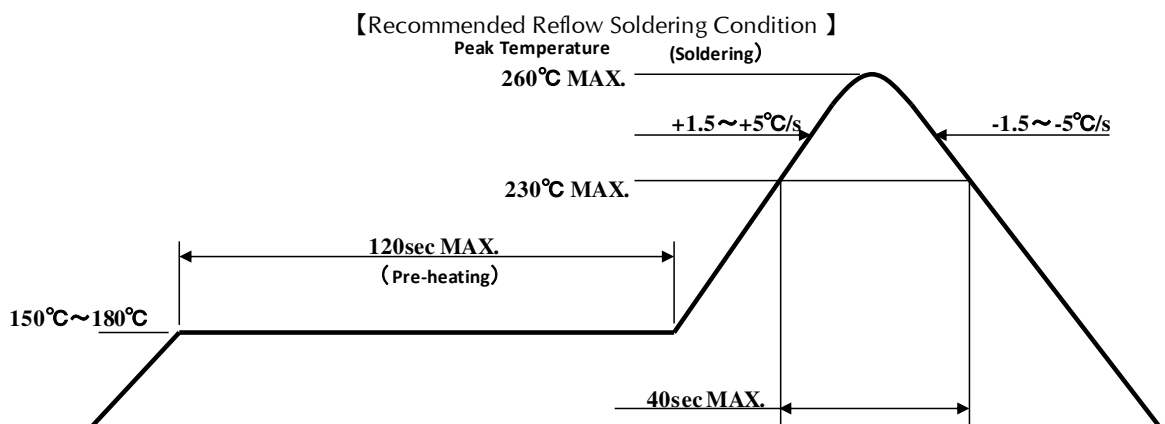




【Soldering Precaution】

(acc.to EIAJ-4701/300)

1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).
2. LED parts including the resin are not stable immediately after soldering (when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.
3. Recommended temperature profile for the Reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .
Please do not repeat the heating process in Reflow process more than twice.



Note 1 Temperature Profile for the reflow should be set to the surface temperature of resin which is on the top of LED. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to twice(2 times Max). When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.

4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touches the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.
5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature before using. Also, please avoid applying any types of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

【Recommended Manual Soldering Condition】

Temperature of Iron Tip	350°C MAX.
Soldering Duration, Time	3sec. Max., 1 time

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended.
《The curing condition, Temperature:150°C Max./Time:300sec. Max.》
7. Flow soldering (dip soldering) is not recommended for this product.
8. Isopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component. Cleaning with ultrasonic is not recommended.

Chemical	Adaptability
Ethyl Alcohol	○
Isopropyl Alcohol	○
Pure Water	○
Trichloroethylene	×
Chloroethene	×
Acetone	×
Thinner	×

【For Electric Static Discharge (ESD)】

This type of LED lamp is highly sensitive to surge voltage generated by the On/Off status change and discharges of static electricity through frictions with synthetic materials, which may cause severe damage to the die or undermine its reliability. Damaged products may experience conditions such as extremely high reverse voltage, or a decrease of forward rise voltage, deteriorating its optical characteristic.

Stanley products are designed to withstand up to 1,000V under the EIAJ ED-4701/300 Test #304 (HBM), and are packed with anti-static components. However, the following precautions and measures are vital in ensuring product quality during shipment.

EIAJ ED-4701/300(304/HBM) Electrification model: $C=100\text{pF}$, $R2=1.5\text{K}\Omega$

1. Electrification/Static Electricity protection

Stanley recommends the following precautions in order to avoid product (die) damage from static electricity , when an operator and other materials electrified by friction coming in contact with the product.

- ① Do not place electrified non-conductive materials near the LED product.
Avoid LED products from coming into contact with metallic materials.(Should the metallic material be electrified , the sudden surge voltage will most likely damage the product.)
- ② Avoid a working process which may cause the LED product to rub against other materials.
- ③ Install ground wires for any equipment, where they can be installed, with measures to avoid static electricity surges.
- ④ Prepare a ESD protective area by placing a Conductive Mattress ($1\text{M}\Omega$ MAX.) and Ionizer to remove any static electricity.
- ⑤ Operators should wear a protective wrist-strap.
- ⑥ Operators should wear conductive work-clothes and shoes.
- ⑦ To handle the products directly, Stanley recommends the use of ceramic, and not metallic, tweezers.

2. Working Environment


- ① A dry environment is more likely to cause static electricity. Although a dry environment is ideal for storage state of LED products, Stanley recommends an environment with approximately 50% humidity after the soldering process.
- ② Recommended static electricity level in the working environment is 150V, which is the same value as Integrated Circuits (which are sensitive to static electricity).

【Other Precautions】

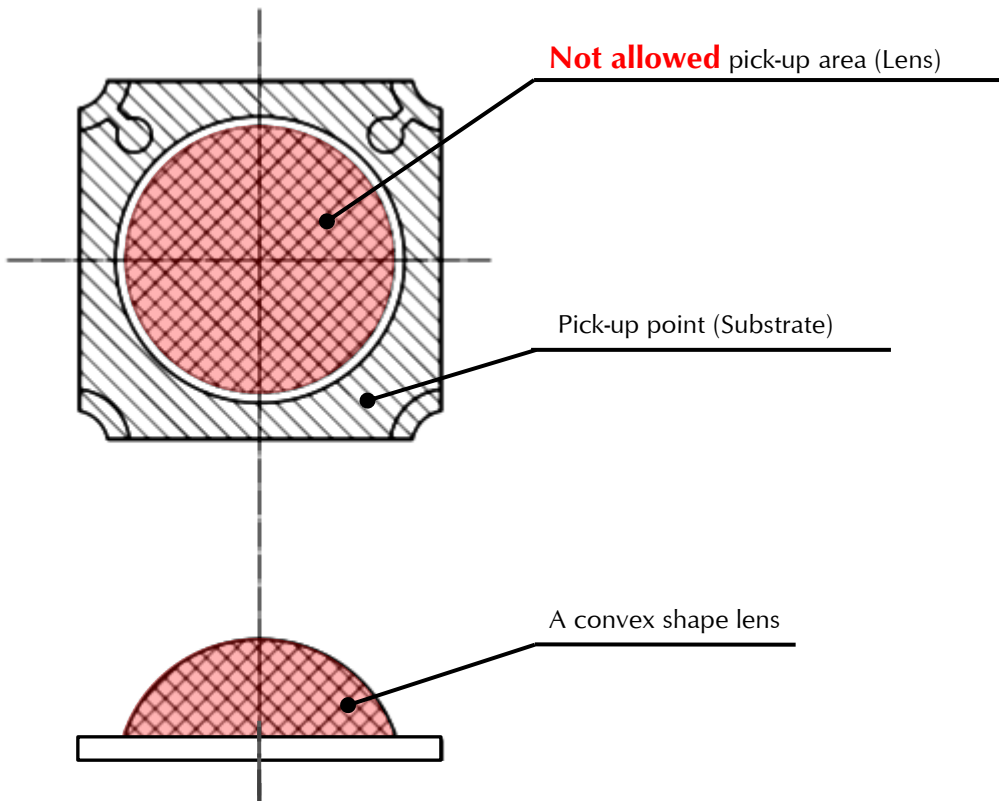
1. Stanley LED Lamps have semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions.
2. Absolute Maximum Ratings are set to prevent LED lamps from failing due to excess stress(temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.
3. In order to ensure high reliability from LED Lamps, variable factors that arise in actual usage conditions should be taken it to account for designing. (Derating of TYP., MAX Forward Voltage, etc.)
4. Please insert Straight Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please be careful when LED is soldered on a metal plate, since solder crack might be caused by heat .
6. Please avoid using this product with materials or products that contain sulfur or chlorine element which may damage the product. Keep the product in desiccator regardless of before or after mounting to prevent corrosive gas. Also make sure there is no corrosive gas which occurs in surrounding area or invade from outside when using products.
7. Please avoid the stick of foreign material because molding resin in the products have adhesiveness. And please don't touch lens portion.
8. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
9. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
10. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
11. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
12. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

【 Handling Precautions for Product Mounting 】

<Recommendation>

Pick-up point with nozzle : Substrate = Surroundings of the lens ( area)
(Shown below)

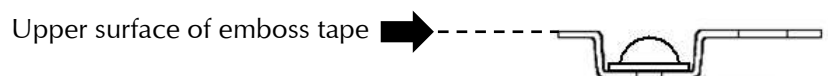
The pick-up point is substrate only because the silicone resin used for the lens is soft.
(If the nozzle makes contact with the lens, the products might be destroyed)



Please adjust the load, pick-up point, nozzle diameter, etc. before mounting because over load can cause breakage of the product.

Recommended nozzle: Inner diameter ϕ 2.0mm to ϕ 2.5mm

Pick-up position of nozzle: From the upper surface of emboss tape



If nozzle size is larger than emboss size, pick-up position should be set 0.1mm higher from upper surface of emboss tape, or it is recommended that the nozzle is punctured to leak the air.

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

【Recommended Storage Condition / Products Warranty Period】

Temperature	+5~30°C
Humidity	Under 70%

In the case of the package unopened , 6 months under 【 Recommended Storage Condition 】, Please avoid rapid transition from low temp. condition to high temp. condition and storage in corroding and dusty environment.

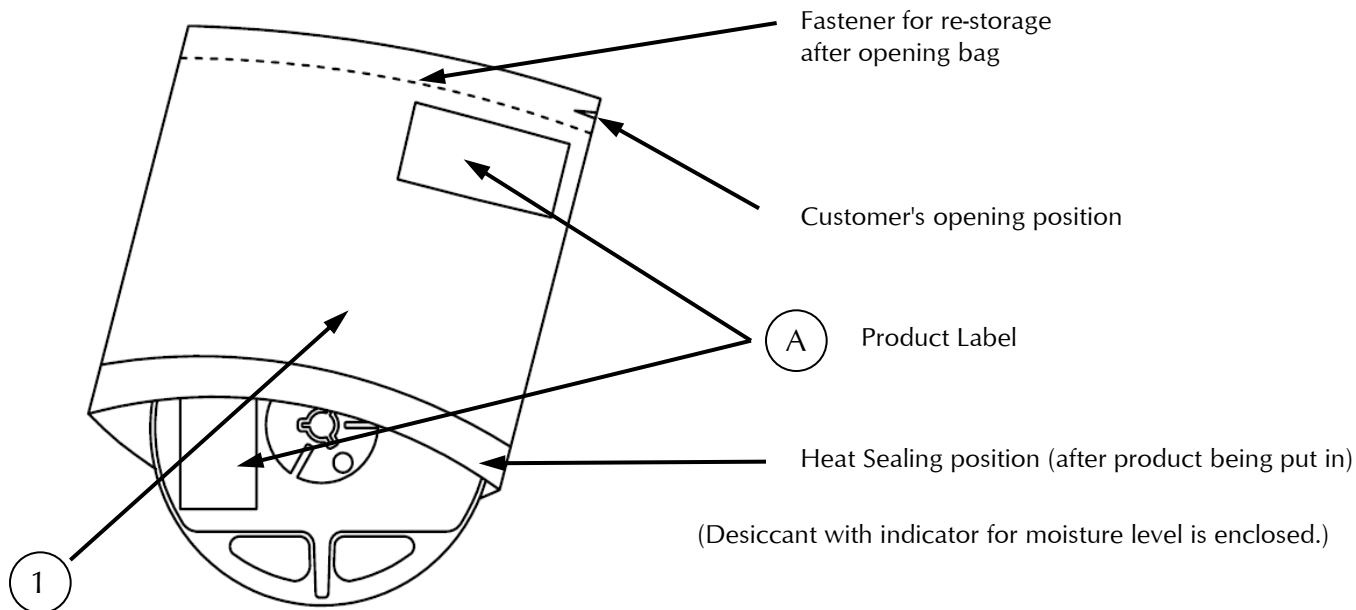
【Time elapsed after Package Opening】

If any LED remain unused, please put it back to moisture-proof bag, reseal the package and store it under the conditions described in the 【 Recommended Storage Condition 】, When over 6 months passed after first opening of package, please do confirm the solder wettability of the terminals.

Baking (moisture removal) is not needed for this product.

Please do not bake LEDs with carrier tape.

【Moisture-proof Packaging Specification】



SYM.	PART NAME	MATELRIAL	REMARKS
①	Moisture-proof bag with Aluminum layer	PET+Al+PE	with ESD protection

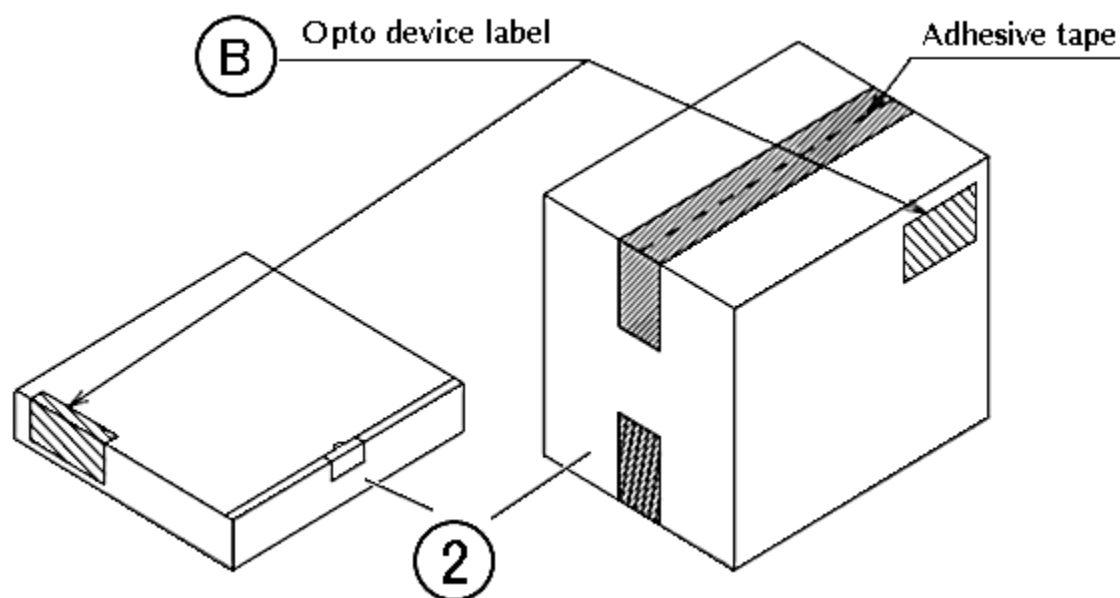
【Packing box】

(RoHS•ELV Compliant)

Box type	Outline dimension L × W × H (mm)	Capacity of the box
Type A	280 × 265 × 45	3 reels
Type B	310 × 235 × 265	15 reels
Type C	440 × 310 × 265	30 reels

The above measure is all the reference value.

Shipping box is selected out of the above table by shipping quantity.



Type A

Material / box : Cardboard C5BF

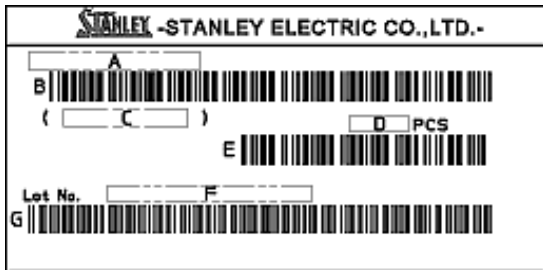
Type B,C

Material / box : Cardboard K5AF
Partition : Cardboard K5AF

【Label Specification】

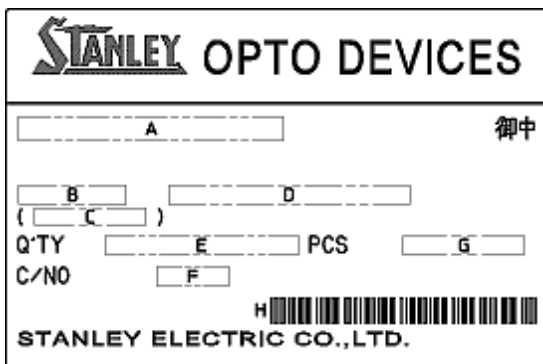
(acc.to JIS-X0503(Code-39))

A Product Label



- A. Parts number
- B. Bar-code for parts number
- C. Parts code (In-house identification code for each parts number)
- D. Packed parts quantity
- E. Bar-Code for packed parts quantity
- F. Lot number & Rank
(refer to Lot Number Notational System for details)
- G. Bar-Code for Lot number & Rank

B Opto Device Label



- A. Customer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

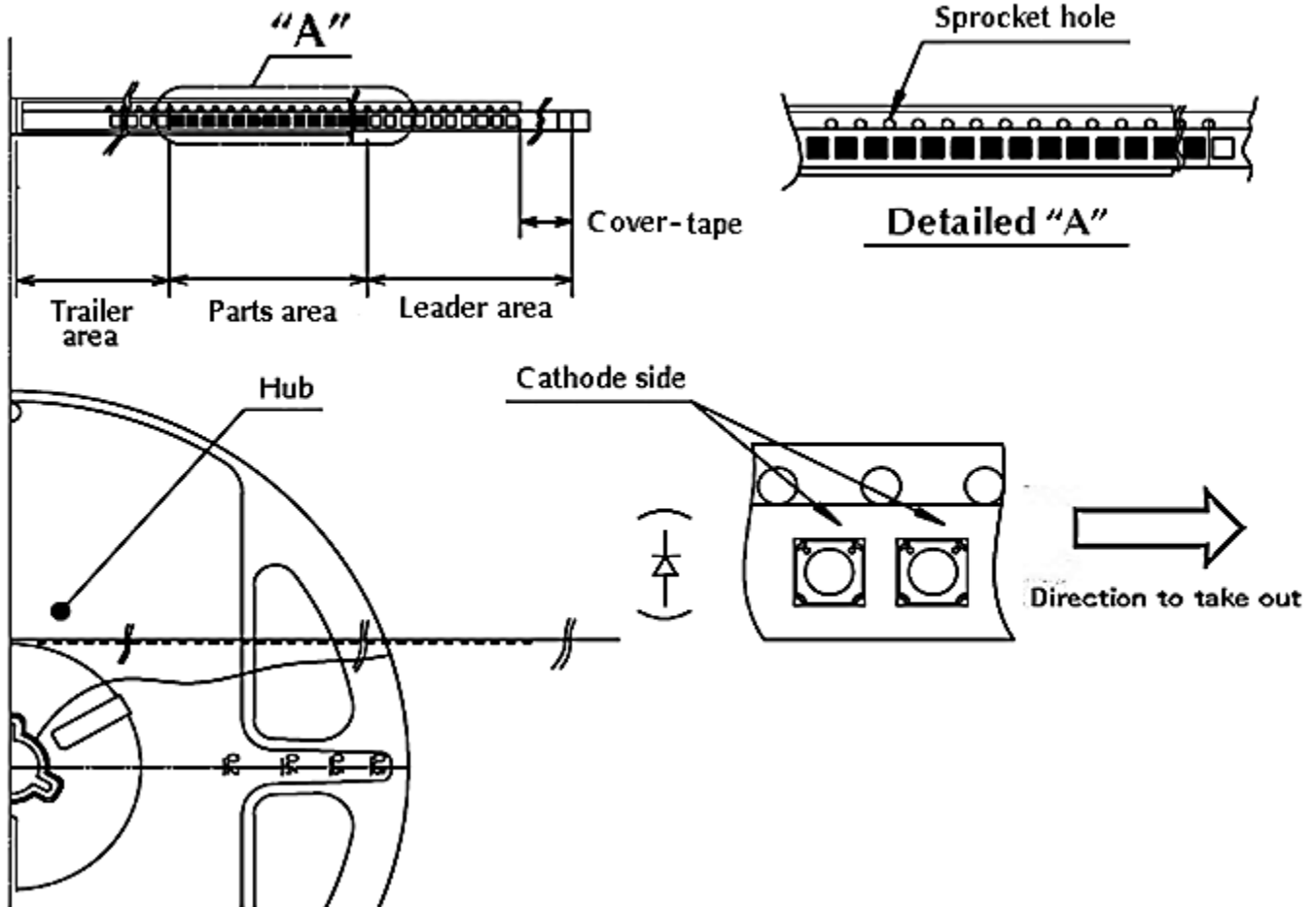
<Remark> Bar-code font : acc.to Code-39(JIX0503)

Taping and Reel Specifications

VTEW1151ASE-57Y-TR

(acc.to JIS-C0806-03)

【Appearance】



Note

"-TR" means Cathode Side of LEDs should be placed on the sprocket-hole side.

Items		Specifications	Remarks
Leader area	Cover-tape	Cover-tape shall be longer than 320mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.
	Carrier-tape	Empty pocket shall be more than 25 pieces (100mm).	Please refer to the above figure for Taping & reel orientation .
Trailer area		Empty pocket shall be more than 40 pieces (160mm) .	The end of taping shall be inserted into a slit of the hub.

Taping and Reel Specifications

VTEW1151ASE-57Y-TR

(acc.to JIS-C0806-03)

【Qty. per Reel】

3,000parts/reel

Minimum Qty. per reel might be 500 parts when getting less than 3,000parts.

In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

【Mechanical strength】

Cover-tape adhesive strength shall be 0.1~1.3N (An angle between carrier-tape and cover-tape shall be170 deg.).

Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

【Others】

Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held.

Empty pocket per reel shall be defined as follows.

Qty./reel	Max. qty. of empty pocket	Remarks
500	1	
1,000	1	
1,500	1	
2,000	2	No continuance
2,500	2	No continuance
3,000	3	No continuance

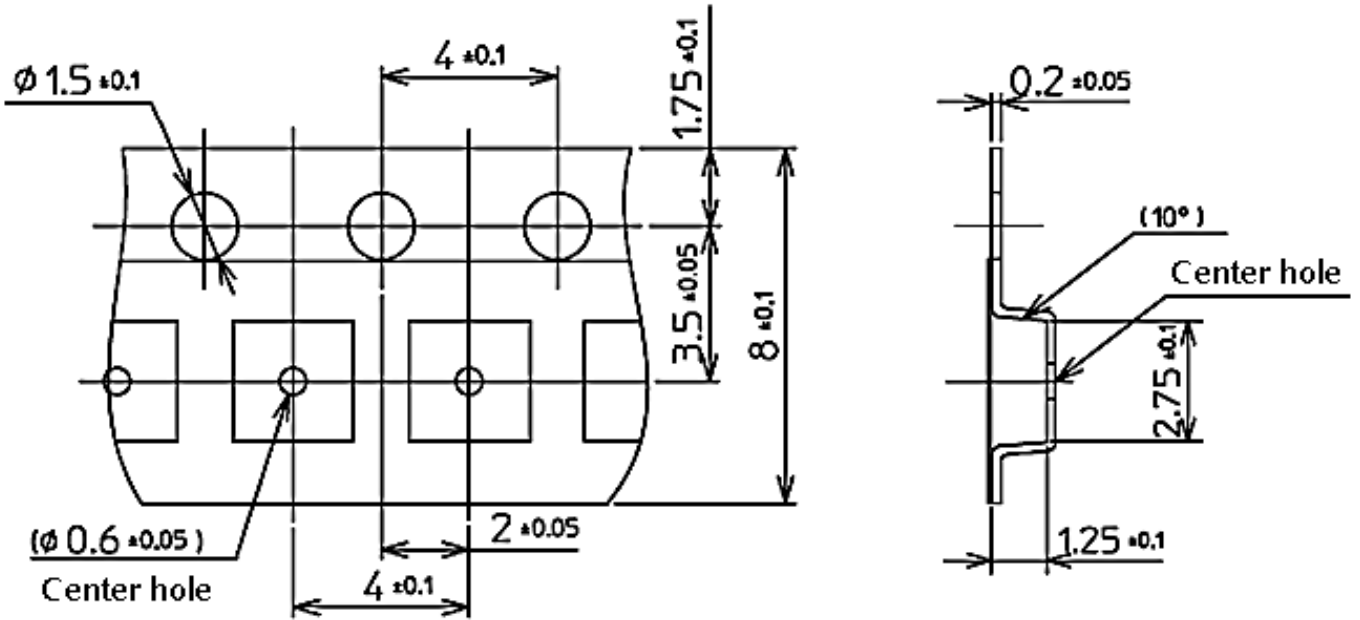
Taping and Reel Specifications

VTEW1151ASE-57Y-TR

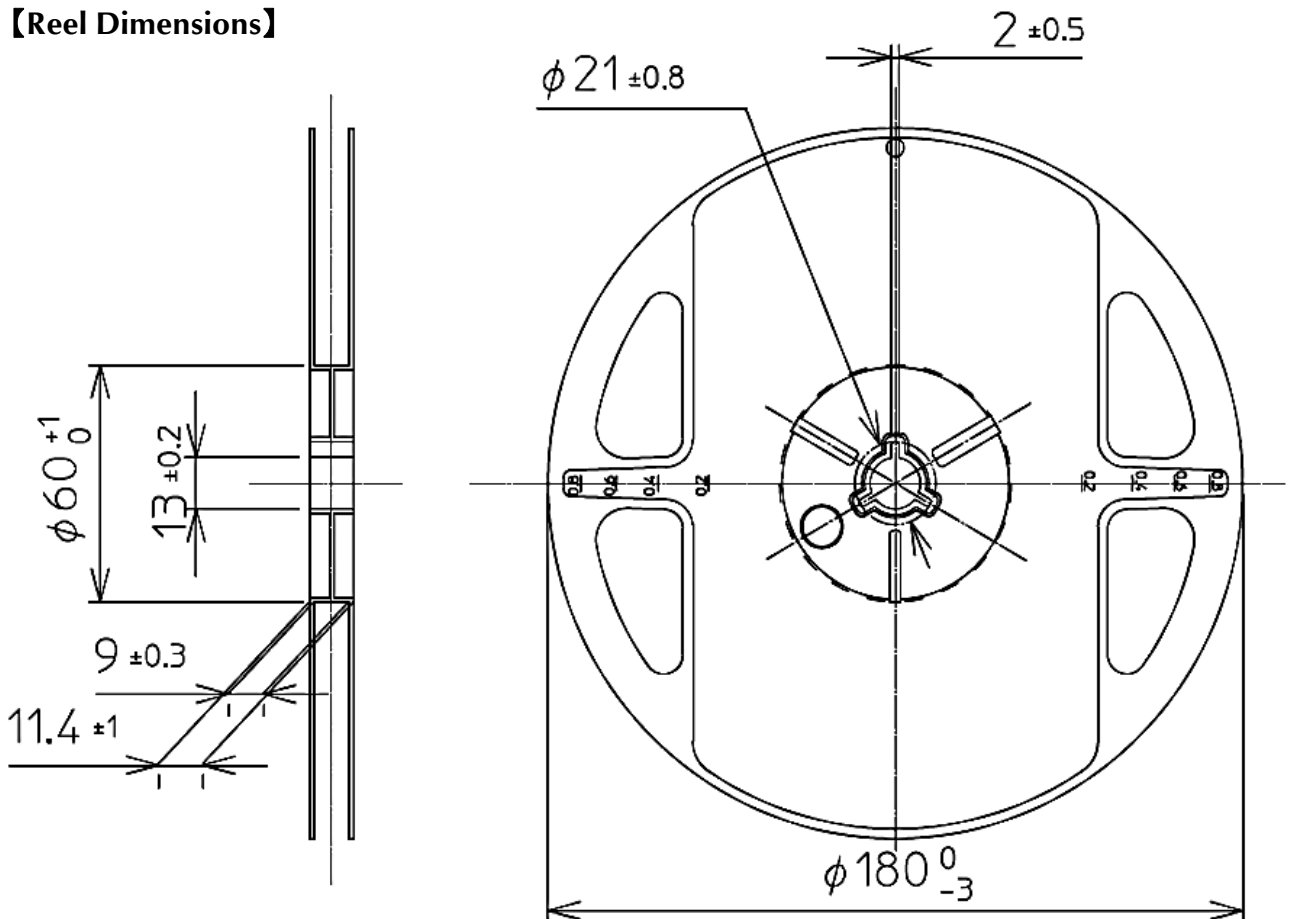
(acc.to JIS-C0806-03)

Unit: mm

【Taping Dimensions】

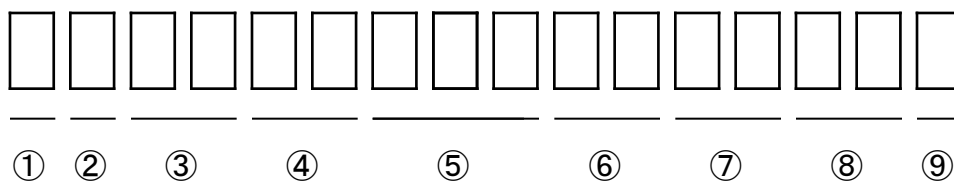


【Reel Dimensions】



Lot Number Notational System

VTEW1151ASE-57Y-TR



① - 1digit : Production Location (Mark identify alphabet)

② - 1digit : Production Year (Last digit of Production Year 2009→9,2010→0,2011→1,···)

③ - 2digits : Production Month (Jan. to Sep. should be 01,02,03,·····)

④ - 2digits : Production Date

⑤ - 3digits : Serial Number

⑥ - 2digits : Tape and Reel following Number

⑦ - 2digits : Luminous Intensity Rank.

(If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified intensity rank, "- ." is used to indicate.)

⑧ - 2digits:Chromaticity Rank

(If chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit.

If there is no identified intensity rank, "- ." is used to indicate.)

Symbol on Lot Number	Chromaticity Rank
7A	57A
7B	57B
7C	57C
7D	57D
7G	57G

⑨- 1digit: VF Rank

If there is no identified VF rank, "- ." is used to indicate.

This product is in compliance with RoHS•ELV.

Prohibition substance and its criteria value of RoHS•ELV are as follows.

- RoHS instruction Refer to following (1)~(6).
- ELV instruction Refer to following (1)~(4).

	Substance Group Name	Criteria Value
(1)	Lead and its compounds	1,000ppm Max
(2)	Cadmium and its compounds	100ppm Max
(3)	Mercury and its compounds	1,000ppm Max
(4)	Hexavalent chromium	1,000ppm Max
(5)	PBB	1,000ppm Max
(6)	PBDE	1,000ppm Max

Reliability Testing Result

VTEW1151ASE-57Y-TR

Test Item	Standard	Test Condition	Duration	Failure
Room Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=25°C I _F =170mA	1,000h	0 / 20
High Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=85°C I _F =150mA	1,000h	0 / 20
Low Temperature Operating Life	EIAJ ED-4701 /100(101)	Ta=-40°C I _F =170mA	1,000h	0 / 20
Wet High Temperature Operating Life	EIAJ ED-4701 /100(102)	Ta=60°C 90% I _F =170mA	1,000h	0 / 20
High Temperature Storage Life	EIAJ ED-4701 /200(201)	Ta=125°C	1,000h	0 / 20
Low Temperature Storage Life	EIAJ ED-4701 /200(202)	Ta=-40°C	1,000h	0 / 20
Thermal Shock	EIAJ ED-4701 /100(105)	Ta=-40°C ~ 125°C (each 15min)	1,000 cycles	0 / 20
Resistance to Reflow Soldering	EIAJ ED-4701 /300(301)	Moisture Soak : 30°C 70% 696h Preheating : 150~180°C 120sec MAX. Soldering : 260°C Peak	Twice	0 / 20
Electrostatic Discharge (ESD) ※ 1	EIAJ ED-4701 /300(304)	C=100pF R2=1.5kΩ ±2,000V	Once of each polarity	0 / 10

※ 1 Reference test

Failure Criteria

Item	Symbol	Conditions	Failure Criteria
Luminous Intensity	I _V	I _F =100mA	Testing Min. Value < Standard Min. Value × 0.7
Forward Voltage	V _F	I _F =100mA	Testing Max. Value ≥ Standard Max. Value × 1.2
Cosmetic appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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